

FEATURES

| Size Design Φ8.0*10.0mm

High Current Handling Capability 10,000A @ 8/20 μs

Low Capacitance and Insertion Loss

| Quick Response and Long Service Life

| Moisture sensitivity level: Level 1



Φ8.0*10.0mm

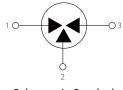
APPLICATION INFORMATION

Communication equipment.

Repeaters, Modems

| Telephone Interface,Line cards.

Data communication equipment.



Schematic Symbol

AGENCY APPROVALS

lcon	Solderability Compliance with 2011/65/EU		
RoHS			
HF	Compliance with IEC61249-2-21:2003		
®	Mean lead free		
<i>IR</i> 。	UL Certificated E505857		

PRODUCT CHARACTERISTICS

Lead Material	Body Material	Terminal Finish	
Copper or Fe-Ni alloy	Ceramics	100% Matte-Tin Plated	



ELECTRICAL PARAMETER

Parameter	Symbol	Rating	Unit
DC Blocking Voltage 1)	100V/s	480-720	V
Impulse Spark ever Voltage	At 1kV/μs	for 99 % of measured values ≤1250	V
Impulse Spark-over Voltage	At 1kV/μs	Typical values of distribution ≤1200	V
Impulse Discharge Current 2)	8/20µs	10	KA
Insulation Resistance	DC=100V	≥ 1	GΩ
Capacitance at 1MHz	V _{DC} =0.5V	≤ 2	рЕ
Operating and Storage Temperature		-40~125	°C

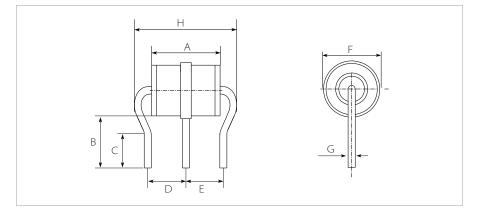
¹⁾ In ionized mode

ENVIRONMENTAL RELIABILITY CHARACTERISTICS

Testing items Technical standards		
High Temperature Storage Test Temperature: 85°C ; Time:2H		
Low Temperature Storage Test Temperature: -40°C ; Time:2H		
Vibration	Frequency: 10-500Hz; Amplitude: 0.15mm; Time:45min	
Resistance of soldering heat Temperature: 260°C; Time of dip soldering: 10s,1t		

NOTE: Up-screen program can be specified by customer's request via contacting Semiware service

PRODUCT DIMENSIONS

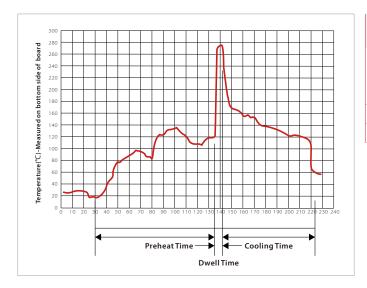


Ref.	Outline Dimensions	
Rei.	Millimeters	
А	10±0.3	
В	7.0±0.5	
С	4.0±0.5	
D	4.4±0.3	
E	4.4±0.3	
F Φ8.0±0.2		
G	Ф1.0	
Н	13±1	

²⁾ Terms and waveforms in accordance with ITU-T Rec. K. 12; IIEC 61643-311



WAVE SOLDERING



	Wave Parameter	Lead-free assembly		
Pre Heat	Temperature Min	100°C		
	Temperature Max	150°C		
	Time(min to max)	60 – 180 secs		
Solder pot Temperature		280°C Max		
Solder Dwell Time		2-5 seconds		

ORDERING INFORMATION

Part Number Size	Ci	iize Marking	Qty/pcs		
	Size		Tray	Inner Box	Carton
SG3R08B600	Ф8.0*10.0mm	愛 SG600 <u>08</u>	100	500	6000



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By QR Code





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